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Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Not For New Designs
Core Processor	M16C/60
Core Size	16-Bit
Speed	20MHz
Connectivity	I ² C, IEBus, SIO, UART/USART
Peripherals	DMA, POR, PWM, Voltage Detect, WDT
Number of I/O	71
Program Memory Size	48KB (48K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 24x10b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-LQFP
Supplier Device Package	80-LQFP (12x12)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/m30280f6hp-u9b

1. Overview

The M16C/28 Group (M16C/28 and M16C/28B) MCU are single-chip control MCU, fabricated using high-performance silicon gate CMOS technology with the M16C/60 series CPU core. The M16C/28 Group (M16C/28 and M16C/28B) are housed in 64-pin and 80-pin plastic molded LQFP packages and also in 85-pin plastic molded TFLGA (Thin Fine Pitch Land Grid Array) package. With a 1-Mbyte address space, this MCU combines advanced instruction manipulation capabilities to process complex instructions by less bytes and execute instructions at higher speed. It includes a multiplier and DMAC adequate for office automation, communication devices and other high-speed processing applications.

The M16C/28 has Normal-ver., T-ver., and V-ver.. The M16C/28B has Normal-ver. only.

This hardware manual describes the Normal-ver. only. Please contact Renesas Technology Corp. for T-ver./V-ver. information.

1.1 Applications

Audio, cameras, office equipment, communication equipment, portable equipment, home appliances (inverter solution), motor control, industrial equipment, etc.

Table 1.2 M16C/28 Group (M16C/28, M16C/28B) (64-Pin Package)

	Item	Performance
CPU	Number of basic instructions	91 instructions
	Minimum instruction execution time	41.7 ns ($f(\text{BCLK}) = 24 \text{ MHz}$, $V_{CC} = 4.2 \text{ V to } 5.5 \text{ V}$) (M16C/28B) 50 ns ($f(\text{BCLK}) = 20 \text{ MHz}$, $V_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$) (M16C/28, M16C/28B) 100 ns ($f(\text{BCLK}) = 10 \text{ MHz}$, $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$) (M16C/28, M16C/28B)
	Operation mode	Single chip mode
	Address space	1M bytes
	Memory capacity	See Table 1.3
Peripheral Function	I/O Port	Input/Output : 55 lines
	Multifunction timer	TimerA:16 bits x 5 channels, TimerB:16 bits x 3 channels Three-phase Motor Control Timer TimerS (Input Capture/Output Compare) : 16bit base timer x 1 channel (Input/Output x 8 channels)
	Serial I/O	2 channels (UART0, UART1) UART, clock synchronous 1 channel (UART2) UART, clock synchronous, I ² C bus ⁽¹⁾ , or IEBus ⁽²⁾ 1 channels (SI/O3, SI/O4) Clock synchronous 1 channel (Multi-Master I ² C bus ⁽¹⁾)
	A/D converter	10 bits x 13 channels
	DMAC	2 channels
	Watchdog timer	15 bits x 1 (with prescaler)
	Interrupt	24 internal and 8 external sources, 4 software sources, 7 levels
	Clock generation circuit	4 circuits • Main clock(*) • Sub-clock(*) • On-chip oscillator • PLL frequency synthesizer (*) Equipped with a built-in feedback resistor
	Oscillation Stop Detect Function	Main clock oscillation stop, re-oscillation detect function
	Voltage detection circuit	Available
Electrical Characteristics	Power supply voltage	$V_{CC} = 4.2 \text{ V to } 5.5 \text{ V}$ ($f(\text{BCLK}) = 24 \text{ MHz}$) (M16C/28) $V_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$ ($f(\text{BCLK}) = 20 \text{ MHz}$) (M16C/28, M16C/28B) $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$ ($f(\text{BCLK}) = 10 \text{ MHz}$) (M16C/28, M16C/28B)
	Power consumption	16 mA ($V_{CC} = 5 \text{ V}$, $f(\text{BCLK}) = 20 \text{ MHz}$) 25 μA ($f(\text{XCIN}) = 32 \text{ KHz}$ on RAM) 3.0 μA ($V_{CC} = 3 \text{ V}$, $f(\text{XCIN}) = 32 \text{ KHz}$, in wait mode) 0.7 μA ($V_{CC} = 3 \text{ V}$, in stop mode)
Flash Memory	Program/erase supply voltage	2.7 V to 5.5 V
	Program and erase endurance	100 times (all space) or 1,000 times (Blocks 0 to 5) /10,000 times (Block A, Block B ⁽³⁾)
Operating Ambient Temperature		-20 to 85°C/-40 to 85°C ⁽³⁾
Package		64-pin plastic mold LQFP

NOTES:

1. I²C bus is a trademark of Koninklijke Philips Electronics N. V.
2. IEBus is a trademark of NEC Electronics Corporation.
3. Refer to **Table 1.5 to 1.7** for number of program/erase.
4. Use PLL frequency synthesizer to use M16C/28B at $f(\text{BCLK}) = 24 \text{ MHz}$.

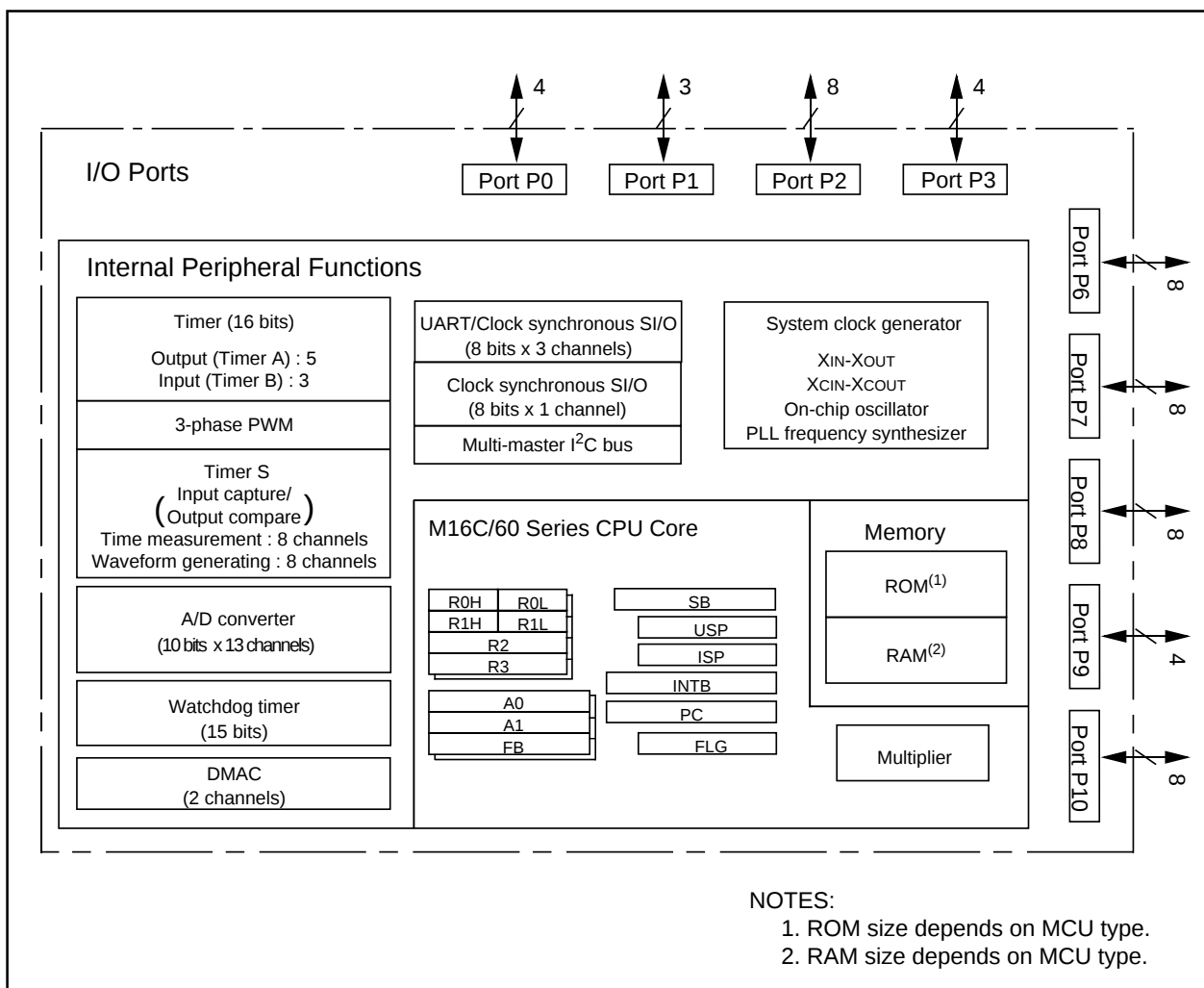


Figure 1.2 M16C/28 Group (M16C/28, M16C/28B), 64-Pin Block Diagram

1.4 Product Information

Tables 1.3 and 1.4 list the M16C/28 Group product information and Figure 1.3 shows the product numbering system. The specifications are partially different between normal-ver. and T/ V-ver..

Table 1.3 M16C/28 Product List -Normal-ver.

As of September, 2006

Type Number	ROM Capacity	RAM Capacity	Package Type	Remarks	Product Code
M30280F6WG (N)	48 K + 4 K	4 K	PTLG0085JB-A (85F0G)	Flash Memory	U3, U5, U7, U9
M30280F8WG (N)	64 K + 4 K	4 K			
M30280FAWG (N)	96 K + 4 K	8 K			
M30280F6HP (N)	48 K + 4 K	4 K	PLQP0080KB-A (80P6Q-A)		
M30280F8HP (N)	64 K + 4 K	4 K			
M30280FAHP (N)	96 K + 4 K	8 K			
M30280FCHP (N)	128 K + 4 K	12 K			
M30281F6HP (N)	48 K + 4 K	4 K	PLQP0064KB-A (64P6Q-A)		
M30281F8HP (N)	64 K + 4 K	4 K			
M30281FAHP (N)	96 K + 4 K	8 K			
M30281FCHP (N)	128 K + 4 K	12 K			
M30280M8-XXXHP (N)	64 K	4 K	PLQP0080KB-A (80P6Q-A)	Mask ROM	U3, U5
M30280MA-XXXHP (N)	96 K	8 K			
M30280MC-XXXHP (N)	128 K	12 K			
M30281M8-XXXHP (N)	64 K	4 K	PLQP0064KB-A (64P6Q-A)		
M30281MA-XXXHP (N)	96 K	8 K			
M30281MC-XXXHP (N)	128 K	12 K			

(N): New

Table 1.4 M16C/28B Product List -Normal-ver.

As of September, 2006

Type Number	ROM Capacity	RAM Capacity	Package Type	Remarks	Product Code
M30280FCBHP (D)	128 K + 4 K	12 K	PLQP0080KB-A (80P6Q-A)	Flash memory	U7
M30281FCBHP (D)	128 K + 4 K	12 K	PLQP0064KB-A (64P6Q-A)		

(D): Under development

Table 1.5 Product Code (Flash Memory-ver.) - M16C/28 Normal-ver., 64-Pin⁽¹⁾/80-Pin⁽¹⁾/85-Pin Package

Product Code	Package	Internal ROM (User Program Space)		Internal ROM (Data Space)		Operating Ambient Temperature
		Program and Erase Endurance	Temperature Range	Program and Erase Endurance	Temperature Range	
U3	Lead free	100	0 to 60°C	100	0 to 60°C	-40 to 85°C
U5					-20 to 85°C	
U7		1,000		10,000	-40 to 85°C	-40 to 85°C
U9					-20 to 85°C	-20 to 85°C

NOTE:

1. The lead contained products, D3, D5, D7 and D9, are put together with U3, U5, U7 and U9 respectively. Lead-free (Sn-Ag-Cu plating) products can be mounted by both conventional Sn-Pb paste and Lead-free paste.

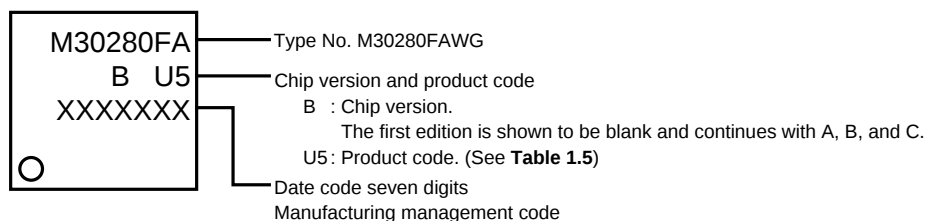
Table 1.6 Product Code (Flash Memory-ver.) - M16C/28B Normal-ver., 64-Pin/85-Pin Package

Product Code	Package	Internal ROM (User Program Space)		Internal ROM (Data Space)		Operating Ambient Temperature
		Program and Erase Endurance	Temperature Range	Program and Erase Endurance	Temperature Range	
U7	Lead-free	1,000	0 to 60°C	10,000	-40 to 85°C	-40 to 85°C

Table 1.7 Product Code (Mask ROM ver.) - M16C/28B Normal-ver., 64-Pin/80-Pin/85-Pin Package

Product Code	Package	Operating Ambient Temperature
U3	Lead-free	-40 to 85°C
U5		-20 to 85°C

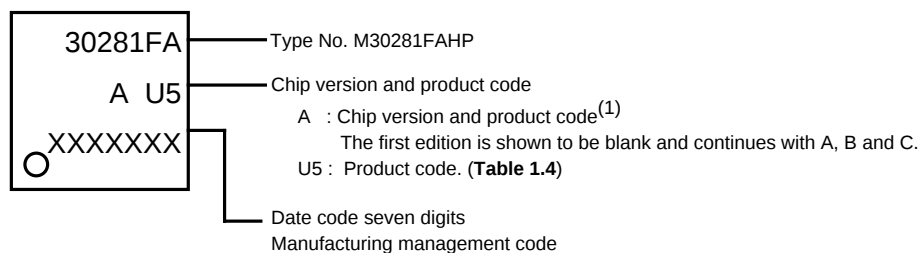
(1) Flash Memory Version, PTLG0085JB-A (85F0G), Normal-ver.



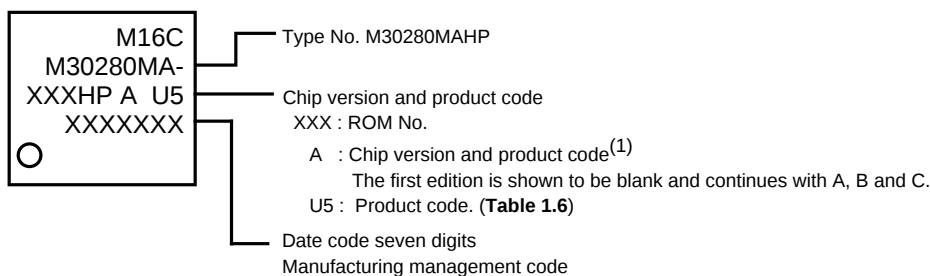
(2) Flash Memory Version, PLQP0080KB-A (80P6Q-A), Normal-ver.



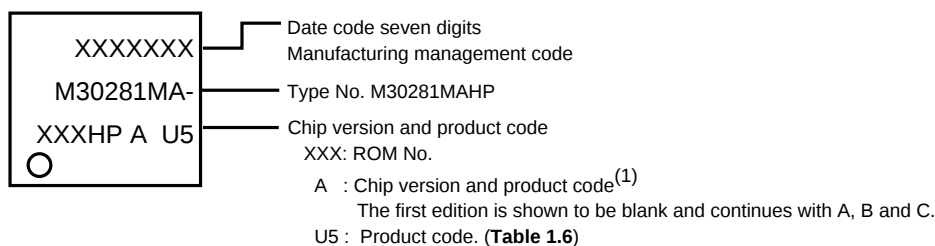
(3) Flash Memory Version, PLQP0064KB-A (64P6Q-A), Normal-ver.



(4) Mask ROM Version, PLQP0080KB-A (80P6Q-A), Normal-ver.



(5) Mask ROM Version, PLQP0064-KB-A (64P6Q-A), Normal-ver.



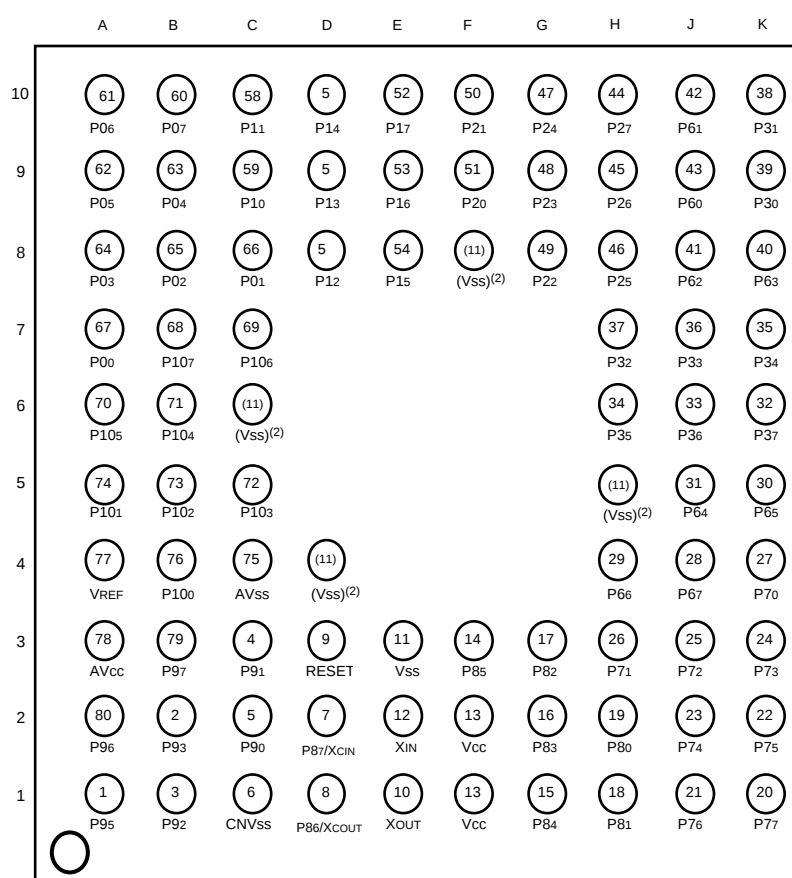
NOTES:

- The following functions are not available in the first version and version A products.
 - Delay trigger mode 0 of A/D conversion
 - Delay trigger mode 1 of A/D conversion

Figure 1.4 Marking Diagram-M16C/28 Normal-ver.

1.5 Pin Assignment

Figures 1.5 to 1.7 show the pin Assignments (top view).



NOTES :

1. The numbers in each grid (circle) show the pin numbers of the M30280FAHP (80P6Q-A package)
2. Connect grids written as (Vss) to Vss(GND) or leave them open.
3. Set PACR2 to PACR0 bits in the PACR register to "0112" before you input and output it after resetting to each pin. When the PACR register is not set, the input and output function of some pins are disabled.

Package: PTLG0085JB-A(85F0G)

Figure 1.5 Pin Assignment (Top View) of 85-pin Package

Table 1.8 Pin Characteristics for 85-pin Package

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Multi-master I ² C bus Pin	Analog Pin	PLQP0080KB-A Pin Number
A1		P95				CLK4		AN25	1
A2		P96				SOUT4		AN26	80
A3	AVcc								78
A4	VREF								77
A5		P101						AN1	74
A6		P105	$\overline{\text{KI1}}$					AN5	70
A7		P00						AN00	67
A8		P03						AN03	64
A9		P05						AN05	62
A10		P06						AN06	61
B1		P92		TB2IN					3
B2		P93						AN24	2
B3		P97				SIN4		AN27	79
B4		P100						AN0	76
B5		P102						AN2	73
B6		P104	$\overline{\text{KI0}}$					AN4	71
B7		P107	$\overline{\text{KI3}}$					AN7	68
B8		P02						AN02	65
B9		P04						AN04	63
B10		P07						AN07	60
C1	CNVss								6
C2		P90		TB0IN					5
C3		P91		TB1IN					4
C4	AVss								75
C5		P103						AN3	72
C6	Vss ⁽¹⁾								(11)
C7		P106	$\overline{\text{KI2}}$					AN6	69
C8		P01						AN01	66
C9		P10						AN20	59
C10		P11						AN21	58
D1	XCOUT	P86							8
D2	XCIN	P87							7
D3	RESET								9
D4	Vss ⁽¹⁾								(11)
D8		P12						AN22	57
D9		P13						AN23	56
D10		P14							55
E1	XOUT								10
E2	XIN								12
E3	Vss								11

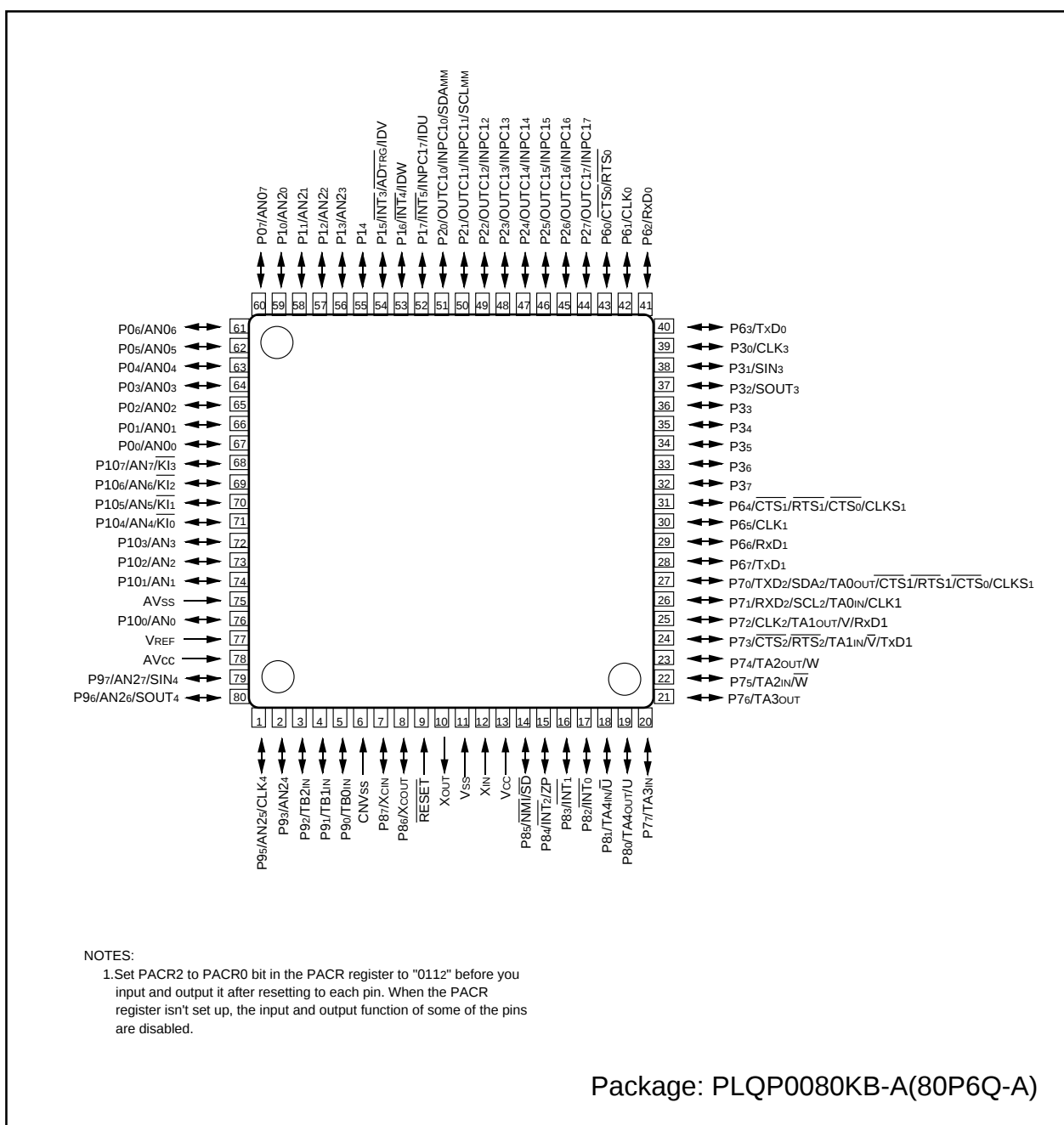


Figure 1.5 Pin Assignment (Top View) of 80-Pin Package

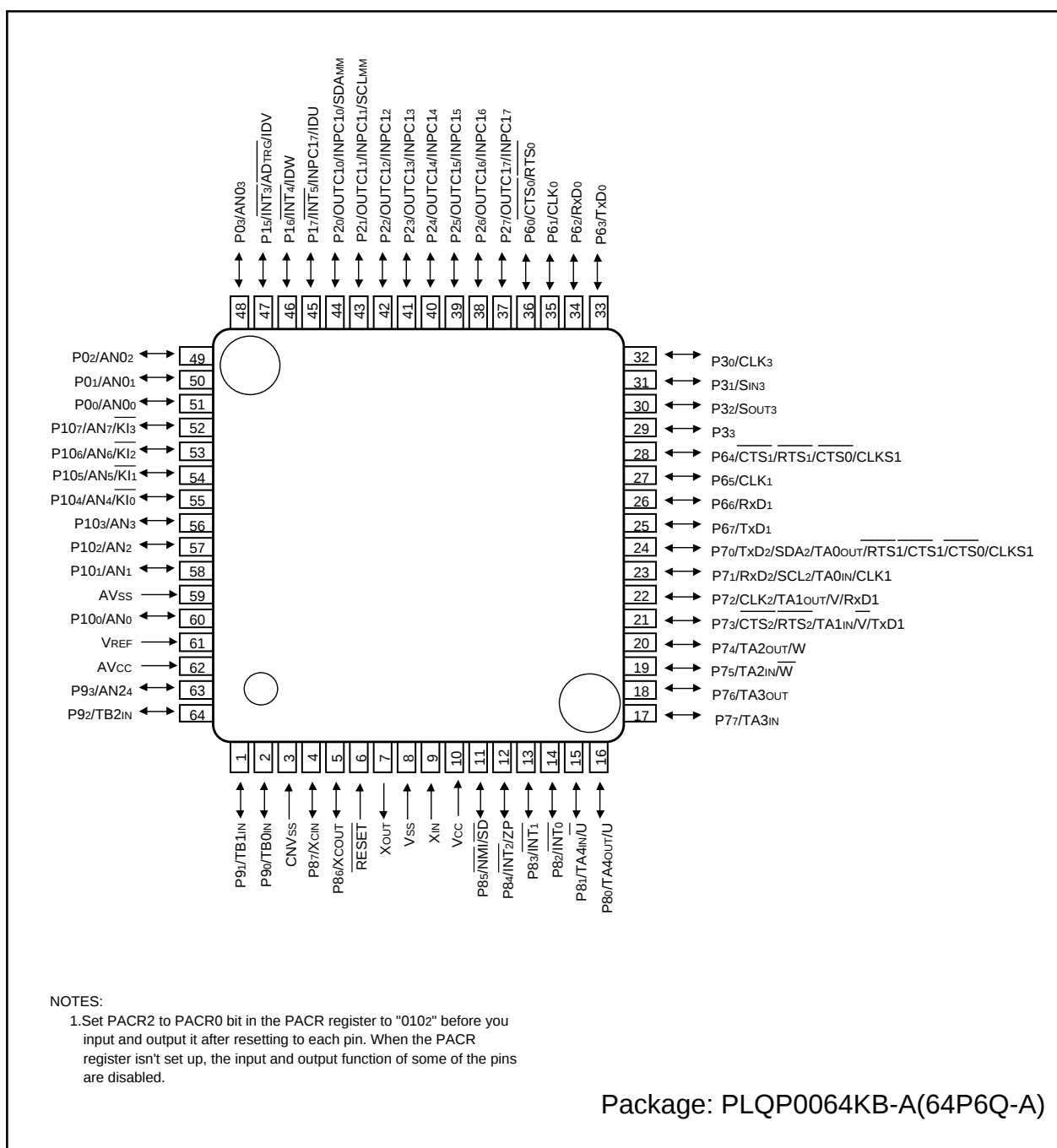


Figure 1.6 Pin Assignment (Top View) of 64-Pin Package

Table 10 Pin Characteristics for 64-Pin Package (Continued)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Multi-master I ² C bus Pin	Analog Pin
41		P23			OUTC13 / INPC13			
42		P22			OUTC12 / INPC12			
43		P21			OUTC11 / INPC11		SCLMM	
44		P20			OUTC10 / INPC10		SDAMM	
45		P17	$\overline{\text{INT}}_5$	IDU	INPC17			
46		P16	$\overline{\text{INT}}_4$	IDW				
47		P15	$\overline{\text{INT}}_3$	IDV				$\overline{\text{ADTRG}}$
48		P03						AN03
49		P02						AN02
50		P01						AN01
51		P00						AN00
52		P107	$\overline{\text{KI}}_3$					AN7
53		P106	$\overline{\text{KI}}_2$					AN6
54		P105	$\overline{\text{KI}}_1$					AN5
55		P104	$\overline{\text{KI}}_0$					AN4
56		P103						AN3
57		P102						AN2
58		P101						AN1
59	AVss							
60		P100						AN0
61	VREF							
62	AVcc							
63		P93						AN24
64		P92		TB2IN				

Table 1.10 Pin Description (80-Pin and 85-Pin Packages only) (Continued)

Classification	Symbol	I/O Type	Function
Serial I/O	CLK4	I/O	Inputs and outputs the transfer clock
	SIN4	I	Inputs serial data
	SOUT4	O	Outputs serial data
A/D Converter	AN04 to AN07 AN20 to AN23 AN25 to AN27	I	Analog input pins for the A/D converter
I/O Ports	P04 to P07 P10 to P14 P34 to P37	I/O	I/O ports for CMOS. Each port can be programmed for input or output under the control of the direction register. An input port can be set, by program, for a pull-up resistor available or for no pull-up resistor available in 4-bit units
	P95 to P97	I/O	I/O ports having equivalent functions to P0

I : Input O : Output I/O : Input and output

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU registers. The register bank is comprised of 7 registers (R0, R1, R2, R3, A0, A1 and FB) out of 13 CPU registers. Two sets of register banks are provided.

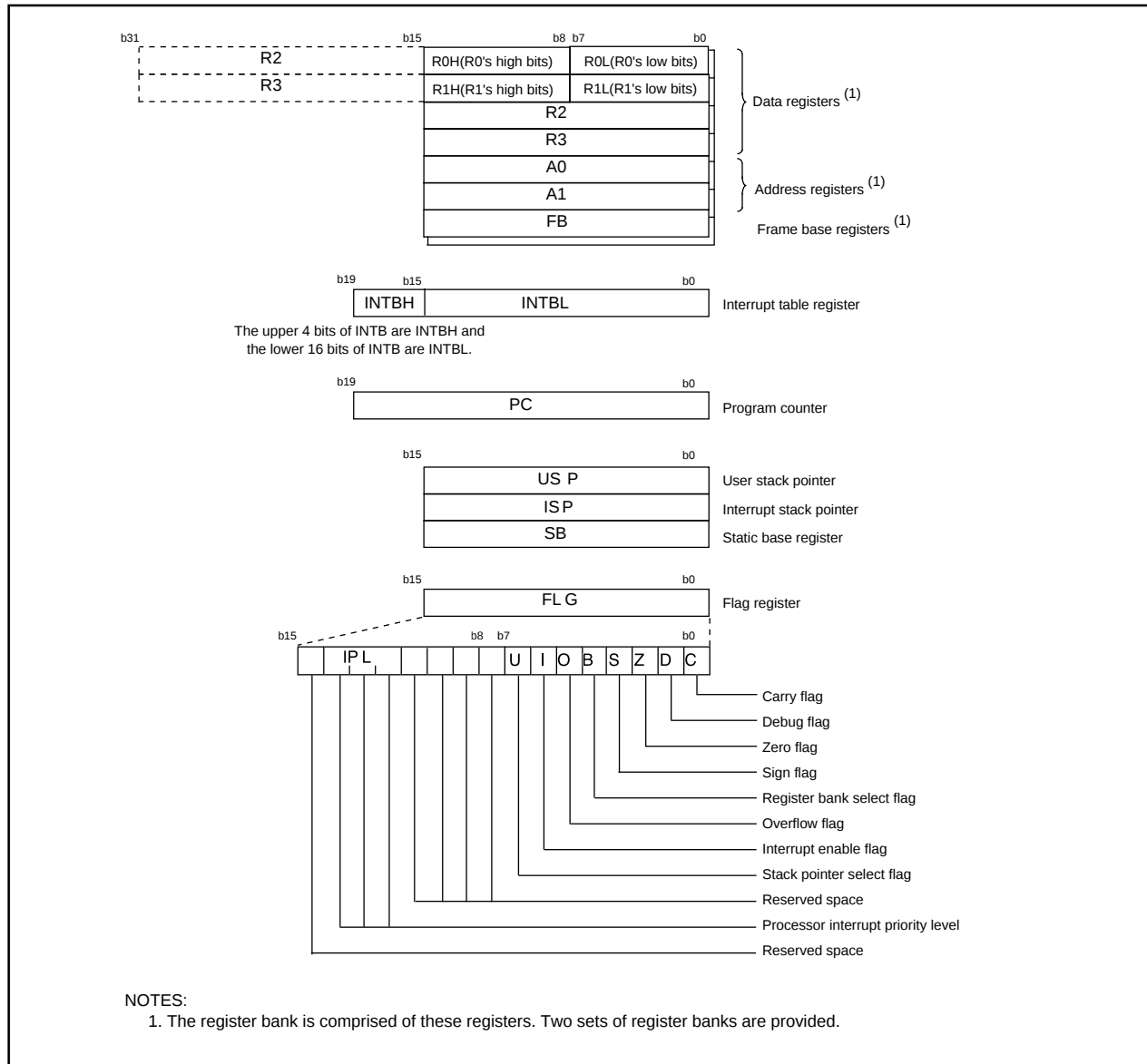


Figure 2.1 Central Processing Unit Register

2.1 Data Registers (R0, R1, R2 and R3)

The R0, R1, R2 and R3 registers are 16 bit registers for transfer and arithmetic/logic operations.

The R0 and R1 registers can be split into high-order bits (R0H, R1H) and low-order bits (R0L, R1L) to be used separately as 8-bit data registers. Conversely, R2 and R0 can be combined with R2 to be used as a 32-bit data register (R2R0). The same applies to R1 and R2.

2.2 Address Registers (A0 and A1)

The register A0 consists of 16 bits, and is used for address register indirect addressing and address register relative addressing. They also are used for transfers and arithmetic/logic operations. A1 is the same as A0. In some instructions, registers A1 and A0 can be combined for use as a 32-bit address register (A1A0).

2.3 Frame Base Register (FB)

FB is configured with 16 bits, and is used for FB relative addressing.

2.4 Interrupt Table Register (INTB)

INTB is configured with 20 bits, indicating the start address of an interrupt vector table.

2.5 Program Counter (PC)

PC is configured with 20 bits, indicating the address of an instruction to be executed.

2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

Stack pointer (SP) comes in two types: USP and ISP, each configured with 16 bits.

Your desired type of stack pointer (USP or ISP) can be selected by the U flag of FLG.

2.7 Static Base Register (SB)

SB is configured with 16 bits, and is used for SB relative addressing.

2.8 Flag Register (FLG)

FLG consists of 11 bits, indicating the CPU status.

2.8.1 Carry Flag (C Flag)

This flag retains a carry, borrow, or shift-out bit that has occurred in the arithmetic/logic unit.

2.8.2 Debug Flag (D Flag)

The D flag is used exclusively for debugging purpose. During normal use, it must be set to 0.

2.8.3 Zero Flag (Z Flag)

This flag is set to 1 when an arithmetic operation resulted in 0; otherwise, it is 0.

2.8.4 Sign Flag (S Flag)

This flag is set to 1 when an arithmetic operation resulted in a negative value; otherwise, it is 0.

2.8.5 Register Bank Select Flag (B Flag)

Register bank 0 is selected when this flag is 0 ; register bank 1 is selected when this flag is 1.

2.8.6 Overflow Flag (O Flag)

This flag is set to 1 when the operation resulted in an overflow; otherwise, it is 0.

2.8.7 Interrupt Enable Flag (I Flag)

This flag enables a maskable interrupt.

Maskable interrupts are disabled when the I flag is 0, and are enabled when the I flag is 1. The I flag is cleared to 0 when the interrupt request is accepted.

2.8.8 Stack Pointer Select Flag (U Flag)

ISP is selected when the U flag is 0; USP is selected when the U flag is 1.

The U flag is cleared to 0 when a hardware interrupt request is accepted or an INT instruction for software interrupt Nos. 0 to 31 is executed.

2.8.9 Processor Interrupt Priority Level (IPL)

IPL is configured with three bits, for specification of up to eight processor interrupt priority levels from level 0 to level 7.

If a requested interrupt has priority greater than IPL, the interrupt is enabled.

2.8.10 Reserved Area

When write to this bit, write 0. When read, its content is indeterminate.

3. Memory

Figure 3.1 is a memory map of the M16C/28 Group (M16C/28, M16C/28B). M16C/28 Group provides 1-Mbyte address space from addresses 00000₁₆ to FFFFF₁₆. The internal ROM is allocated lower addresses beginning with address FFFFF₁₆. For example, 64 Kbytes internal ROM is allocated addresses F0000₁₆ to FFFFF₁₆.

Two 2-Kbyte internal ROM areas, block A and block B, are available in the flash memory version. The blocks are allocated addresses F000₁₆ to FFFF₁₆.

The fixed interrupt vector tables are allocated addresses FFFDC₁₆ to FFFFF₁₆. It stores the starting address of each interrupt routine. See the section on interrupts for details.

The internal RAM is allocated higher addresses beginning with address 00400₁₆. For example, 4-Kbytes internal RAM is allocated addresses 00400₁₆ to 013FF₁₆. Besides storing data, it becomes stacks when the subroutine is called or an interrupt is acknowledged.

SFR, consisting of control registers for peripheral functions such as I/O port, A/D converter, serial I/O, timers is allocated addresses 00000₁₆ to 003FF₁₆. All blank spaces within SFR are reserved and cannot be accessed by users.

The special page vector table is allocated to the addresses FFE00₁₆ to FFFDB₁₆. This vector is used by the JMPS or JSRS instruction. For details, refer to the **M16C/60 and M16C/20 Series Software Manual**.

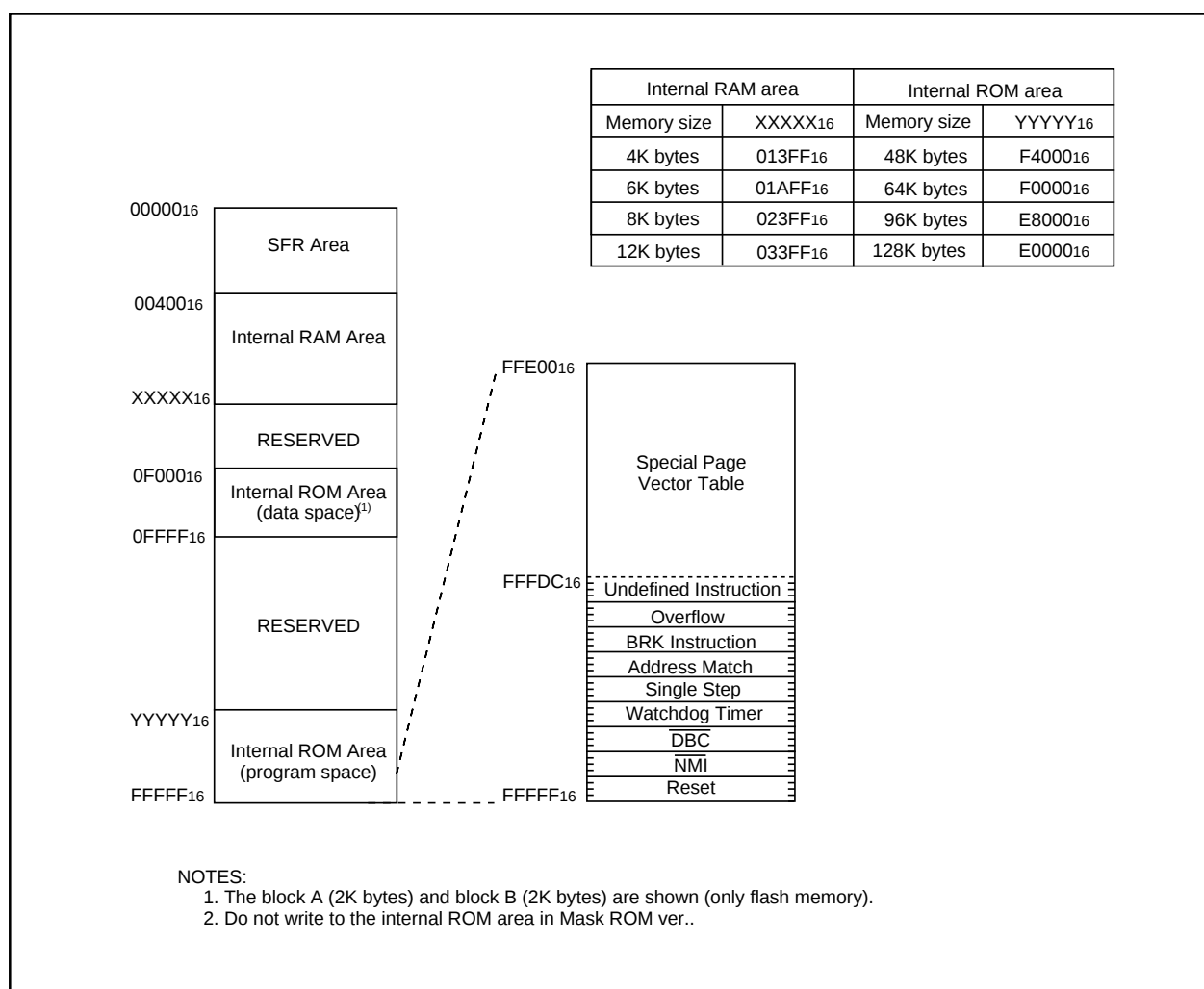


Figure 3.1 Memory Map

4. Special Function Register (SFR)

SFR (Special Function Register) is the control register of peripheral functions. **Tables 4.1 to 4.7** list the SFR information.

Table 4.1 SFR Information⁽¹⁾

Address	Register	Symbol	After Reset
0000 ₁₆			
0001 ₁₆			
0002 ₁₆			
0003 ₁₆			
0004 ₁₆	Processor mode register 0	PM0	0016
0005 ₁₆	Processor mode register 1	PM1	000010002
0006 ₁₆	System clock control register 0	CM0	010010002
0007 ₁₆	System clock control register 1	CM1	001000002
0008 ₁₆			
0009 ₁₆	Address match interrupt enable register	AIER	XXXXXX002
000A ₁₆	Protect register	PRCR	XX0000002
000B ₁₆			
000C ₁₆	Oscillation stop detection register ⁽²⁾	CM2	0X0000102
000D ₁₆			
000E ₁₆	Watchdog timer start register	WDTS	XX16
000F ₁₆	Watchdog timer control register	WDC	00XXXXXX2
0010 ₁₆	Address match interrupt register 0	RMAD0	0016
0011 ₁₆			0016
0012 ₁₆			X016
0013 ₁₆			
0014 ₁₆	Address match interrupt register 1	RMAD1	0016
0015 ₁₆			0016
0016 ₁₆			X016
0017 ₁₆			
0018 ₁₆			
0019 ₁₆	Voltage detection register 1 ⁽³⁾	VCR1	000010002
001A ₁₆	Voltage detection register 2 ⁽³⁾	VCR2	0016
001B ₁₆			
001C ₁₆	PLL control register 0	PLC0	0001X0102
001D ₁₆			
001E ₁₆	Processor mode register 2	PM2	XXX000002
001F ₁₆	Low voltage detection interrupt register	D4INT	0016
0020 ₁₆	DMA0 source pointer	SAR0	XX16
0021 ₁₆			XX16
0022 ₁₆			XX16
0023 ₁₆			
0024 ₁₆	DMA0 destination pointer	DAR0	XX16
0025 ₁₆			XX16
0026 ₁₆			XX16
0027 ₁₆			
0028 ₁₆	DMA0 transfer counter	TCR0	XX16
0029 ₁₆			XX16
002A ₁₆			
002B ₁₆			
002C ₁₆	DMA0 control register	DM0CON	00000X002
002D ₁₆			
002E ₁₆			
002F ₁₆			
0030 ₁₆	DMA1 source pointer	SAR1	XX16
0031 ₁₆			XX16
0032 ₁₆			XX16
0033 ₁₆			
0034 ₁₆	DMA1 destination pointer	DAR1	XX16
0035 ₁₆			XX16
0036 ₁₆			XX16
0037 ₁₆			
0038 ₁₆	DMA1 transfer counter	TCR1	XX16
0039 ₁₆			XX16
003A ₁₆			
003B ₁₆			
003C ₁₆	DMA1 control register	DM1CON	00000X002
003D ₁₆			
003E ₁₆			
003F ₁₆			

NOTES:

1. The blank spaces are reserved. No access is allowed.
2. The CM20, CM21, and CM27 bits do not change at oscillation stop detection reset.
3. This register does not change at software reset, watchdog timer reset and oscillation stop detection reset.

X : Undefined

Table 4.4 SFR Information(4)(1)

Address	Register	Symbol	After Reset
0300 ₁₆ 0301 ₁₆	TM, WG register 0	G1TM0, G1PO0	XX ₁₆ XX ₁₆
0302 ₁₆ 0303 ₁₆	TM, WG register 1	G1TM1, G1PO1	XX ₁₆ XX ₁₆
0304 ₁₆ 0305 ₁₆	TM, WG register 2	G1TM2, G1PO2	XX ₁₆ XX ₁₆
0306 ₁₆ 0307 ₁₆	TM, WG register 3	G1TM3, G1PO3	XX ₁₆ XX ₁₆
0308 ₁₆ 0309 ₁₆	TM, WG register 4	G1TM4, G1PO4	XX ₁₆ XX ₁₆
030A ₁₆ 030B ₁₆	TM, WG register 5	G1TM5, G1PO5	XX ₁₆ XX ₁₆
030C ₁₆ 030D ₁₆	TM, WG register 6	G1TM6, G1PO6	XX ₁₆ XX ₁₆
030E ₁₆ 030F ₁₆	TM, WG register 7	G1TM7, G1PO7	XX ₁₆ XX ₁₆
0310 ₁₆	WG control register 0	G1POCR0	0X00XX002
0311 ₁₆	WG control register 1	G1POCR1	0X00XX002
0312 ₁₆	WG control register 2	G1POCR2	0X00XX002
0313 ₁₆	WG control register 3	G1POCR3	0X00XX002
0314 ₁₆	WG control register 4	G1POCR4	0X00XX002
0315 ₁₆	WG control register 5	G1POCR5	0X00XX002
0316 ₁₆	WG control register 6	G1POCR6	0X00XX002
0317 ₁₆	WG control register 7	G1POCR7	0X00XX002
0318 ₁₆	TM control register 0	G1TMCR0	00 ₁₆
0319 ₁₆	TM control register 1	G1TMCR1	00 ₁₆
031A ₁₆	TM control register 2	G1TMCR2	00 ₁₆
031B ₁₆	TM control register 3	G1TMCR3	00 ₁₆
031C ₁₆	TM control register 4	G1TMCR4	00 ₁₆
031D ₁₆	TM control register 5	G1TMCR5	00 ₁₆
031E ₁₆	TM control register 6	G1TMCR6	00 ₁₆
031F ₁₆	TM control register 7	G1TMCR7	00 ₁₆
0320 ₁₆ 0321 ₁₆	Base timer register	G1BT	XX ₁₆ XX ₁₆
0322 ₁₆	Base timer control register 0	G1BCR0	00 ₁₆
0323 ₁₆	Base timer control register 1	G1BCR1	00 ₁₆
0324 ₁₆	TM prescale register 6	G1TPR6	00 ₁₆
0325 ₁₆	TM prescale register 7	G1TPR7	00 ₁₆
0326 ₁₆	Function enable register	G1FE	00 ₁₆
0327 ₁₆	Function select register	G1FS	00 ₁₆
0328 ₁₆ 0329 ₁₆	Base timer reset register	G1BTRR	XX ₁₆ XX ₁₆
032A ₁₆ 032B ₁₆	Divider register	G1DV	00 ₁₆
032C ₁₆			
032D ₁₆			
032E ₁₆			
032F ₁₆			
0330 ₁₆	Interrupt request register	G1IR	XX ₁₆
0331 ₁₆	Interrupt enable register 0	G1IE0	00 ₁₆
0332 ₁₆	Interrupt enable register 1	G1IE1	00 ₁₆
0333 ₁₆			
0334 ₁₆			
0335 ₁₆			
0336 ₁₆			
0337 ₁₆			
0338 ₁₆			
0339 ₁₆			
033A ₁₆			
033B ₁₆			
033C ₁₆			
033D ₁₆			
033E ₁₆	NMI digital debounce register	NDDR	FF ₁₆
033F ₁₆	P17 digital debounce register	P17DDR	FF ₁₆

Note 1: The blank spaces are reserved. No access is allowed.

X : Undefined

Table 4.6 SFR Information(6)⁽¹⁾

Address	Register	Symbol	After Reset
0380 ₁₆	Count start flag	TABSR	00 ₁₆
0381 ₁₆	Clock prescaler reset flag	CPSRF	0XXXXXX2
0382 ₁₆	One-shot start flag	ONSF	00 ₁₆
0383 ₁₆	Trigger select register	TRGSR	00 ₁₆
0384 ₁₆	Up-down flag	UDF	00 ₁₆
0385 ₁₆			
0386 ₁₆	Timer A0 register	TA0	XX ₁₆
0387 ₁₆			XX ₁₆
0388 ₁₆	Timer A1 register	TA1	XX ₁₆
0389 ₁₆			XX ₁₆
038A ₁₆	Timer A2 register	TA2	XX ₁₆
038B ₁₆			XX ₁₆
038C ₁₆	Timer A3 register	TA3	XX ₁₆
038D ₁₆			XX ₁₆
038E ₁₆	Timer A4 register	TA4	XX ₁₆
038F ₁₆			XX ₁₆
0390 ₁₆	Timer B0 register	TB0	XX ₁₆
0391 ₁₆			XX ₁₆
0392 ₁₆	Timer B1 register	TB1	XX ₁₆
0393 ₁₆			XX ₁₆
0394 ₁₆	Timer B2 register	TB2	XX ₁₆
0395 ₁₆			XX ₁₆
0396 ₁₆	Timer A0 mode register	TA0MR	00 ₁₆
0397 ₁₆	Timer A1 mode register	TA1MR	00 ₁₆
0398 ₁₆	Timer A2 mode register	TA2MR	00 ₁₆
0399 ₁₆	Timer A3 mode register	TA3MR	00 ₁₆
039A ₁₆	Timer A4 mode register	TA4MR	00 ₁₆
039B ₁₆	Timer B0 mode register	TB0MR	00XX00002
039C ₁₆	Timer B1 mode register	TB1MR	00XX00002
039D ₁₆	Timer B2 mode register	TB2MR	00XX00002
039E ₁₆	Timer B2 special mode register	TB2SC	X00000002
039F ₁₆			
03A0 ₁₆	UART0 transmit/receive mode register	U0MR	00 ₁₆
03A1 ₁₆	UART0 bit rate generator	U0BRG	XX ₁₆
03A2 ₁₆	UART0 transmit buffer register	U0TB	XX ₁₆
03A3 ₁₆			XX ₁₆
03A4 ₁₆	UART0 transmit/receive control register 0	U0C0	000010002
03A5 ₁₆	UART0 transmit/receive control register 1	U0C1	000000102
03A6 ₁₆	UART0 receive buffer register	U0RB	XX ₁₆
03A7 ₁₆			XX ₁₆
03A8 ₁₆	UART1 transmit/receive mode register	U1MR	00 ₁₆
03A9 ₁₆	UART1 bit rate generator	U1BRG	XX ₁₆
03AA ₁₆	UART1 transmit buffer register	U1TB	XX ₁₆
03AB ₁₆			XX ₁₆
03AC ₁₆	UART1 transmit/receive control register 0	U1C0	000010002
03AD ₁₆	UART1 transmit/receive control register 1	U1C1	000000102
03AE ₁₆	UART1 receive buffer register	U1RB	XX ₁₆
03AF ₁₆			XX ₁₆
03B0 ₁₆	UART transmit/receive control register 2	UCON	X00000002
03B1 ₁₆			
03B2 ₁₆			
03B3 ₁₆			
03B4 ₁₆			
03B5 ₁₆			
03B6 ₁₆			
03B7 ₁₆			
03B8 ₁₆	DMA0 request cause select register	DM0SL	00 ₁₆
03B9 ₁₆			
03BA ₁₆	DMA1 request cause select register	DM1SL	00 ₁₆
03BB ₁₆			
03BC ₁₆			
03BD ₁₆			
03BE ₁₆			
03BF ₁₆			

Note 1: The blank spaces are reserved. No access is allowed.

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